

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
-20V	850mΩ@-4.5V	-0.65A
	1200mΩ@-2.5V	
	2000mΩ@-1.8V	

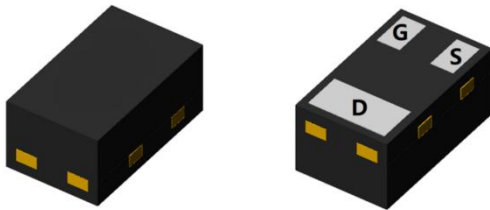
## Feature

- Trench Power LV MOSFET technology
- High Density Cell Design for Low  $R_{DS(ON)}$
- High Speed switching
- ESD Protected Up to 2.0KV(HBM)

## Application

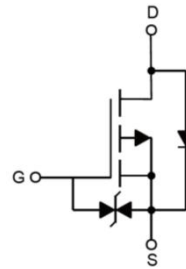
- Interfacing, Logic switch
- Load switch
- Power management

## Package

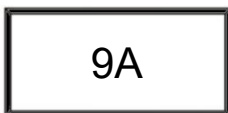


DFN1006-3L

## Circuit diagram



## Marking



### Absolute maximum ratings ( $T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current	$I_D$	-0.65	A
Continuous Drain Current ( $T_A=70^{\circ}\text{C}$ )	$I_D$	-0.52	A
Pulsed Drain Current <sup>1)</sup>	$I_{DM}$	-2	A
Power Dissipation	$P_D$	0.9	W
Thermal Resistance from Junction to Ambient <sup>2)</sup>	$R_{\theta JA}$	138	$^{\circ}\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^{\circ}\text{C}$
Storage Temperature	$T_{STG}$	-55 ~ +150	$^{\circ}\text{C}$

### Electrical characteristics ( $T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{V}, I_D = -250\mu\text{A}$	-20			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -20\text{V}, V_{GS} = 0\text{V}, T_C = 25^{\circ}\text{C}$			-1	$\mu\text{A}$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 10\text{V}, V_{DS} = 0\text{V}$			$\pm 10$	$\mu\text{A}$
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-0.35	-0.62	-1.2	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = -4.5\text{V}, I_D = -0.5\text{A}$		580	850	m $\Omega$
		$V_{GS} = -2.5\text{V}, I_D = -0.3\text{A}$		855	1200	
		$V_{GS} = -1.8\text{V}, I_D = -0.2\text{A}$		1350	2000	
<b>Dynamic characteristics<sup>3)</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -10\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$		71		pF
Output Capacitance	$C_{oss}$			20		
Reverse Transfer Capacitance	$C_{rss}$			15		
Total Gate Charge	$Q_g$	$V_{DD} = -10\text{V}, V_{GS} = -4.5\text{V}, I_D = -0.5\text{A}$		1.24		nC
Gate-Source Charge	$Q_{gs}$			0.37		
Gate-Drain Charge	$Q_{gd}$			0.27		
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -10\text{V}, V_{GS} = -4.5\text{V}, R_L = 2.5\Omega, R_{GEN} = 3\Omega$		4		nS
Turn-on rise time	$t_r$			19		
Turn-off delay time	$t_{d(off)}$			16		
Turn-off fall time	$t_f$			25		
<b>Source-Drain Diode characteristics</b>						
Diode Forward Current	$I_S$				-0.65	A
Diode Forward voltage	$V_{SD}$	$V_{GS} = 0\text{V}, I_S = -0.65\text{A}$			-1.2	V
Reverse Recovery Time	$t_{rr}$	$I_F = -0.5\text{A}, di/dt = -20\text{A}/\mu\text{s}$		26		nS
Reverse Recovery Charge	$Q_{rr}$			0.97		nC

Notes:

- 1) Pulse Test: Pulse Widths  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .
- 2) The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^{\circ}\text{C}$ . The Power dissipation  $P_D$  is based on  $R_{\theta JA}$  and the maximum allowed junction temperature of  $150^{\circ}\text{C}$ . The value in any given application depends on the user's specific board design, and the maximum temperature of  $150^{\circ}\text{C}$  may be used if the PCB allows it to.
- 3) Guaranteed by design, not subject to production testing.

## Typical Characteristics

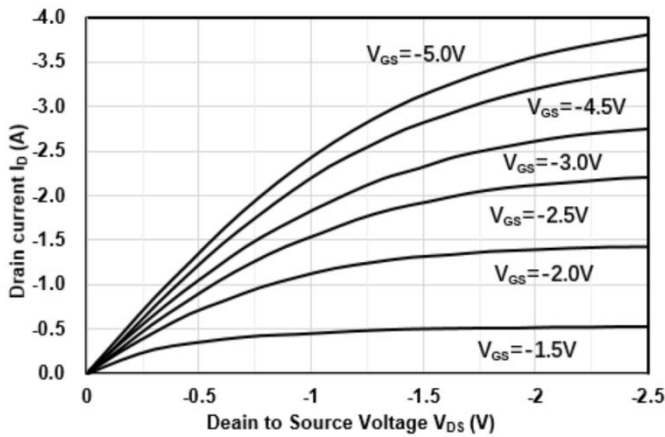


Figure1. Output Characteristics

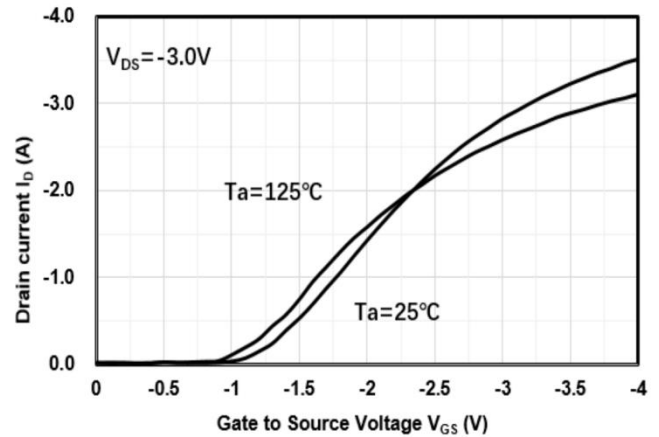


Figure2. Transfer Characteristics

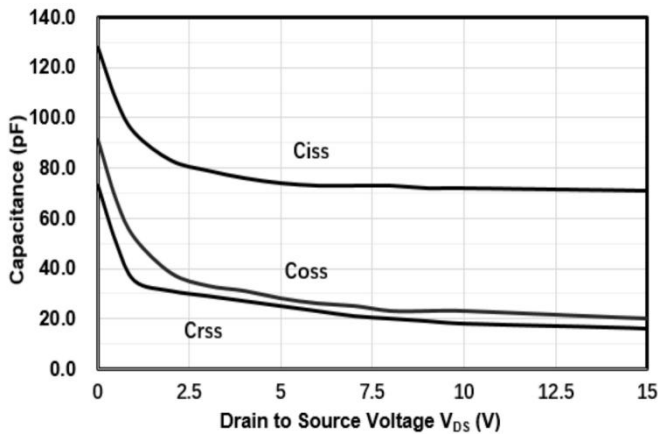


Figure3. Capacitance Characteristics

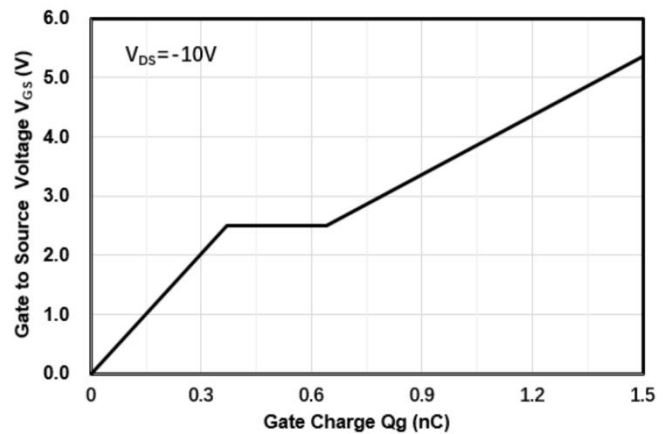


Figure4. Gate Charge

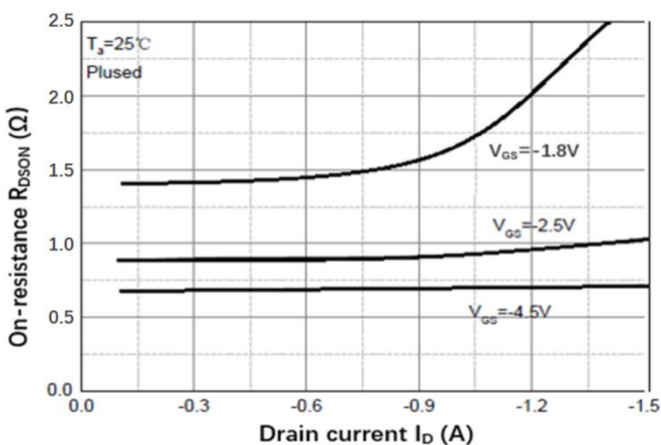


Figure5. Drain-Source on Resistance

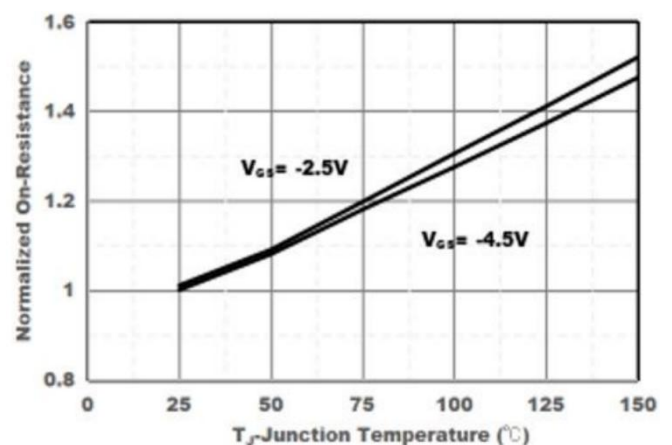


Figure6. Drain-Source on Resistance

## Typical Characteristics

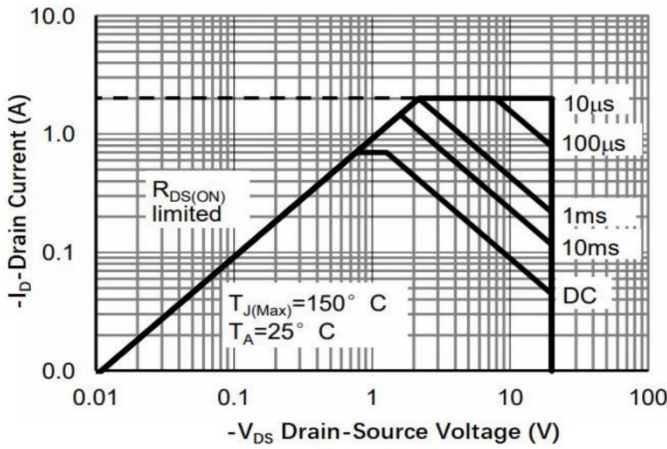


Figure7. Safe Operation Area

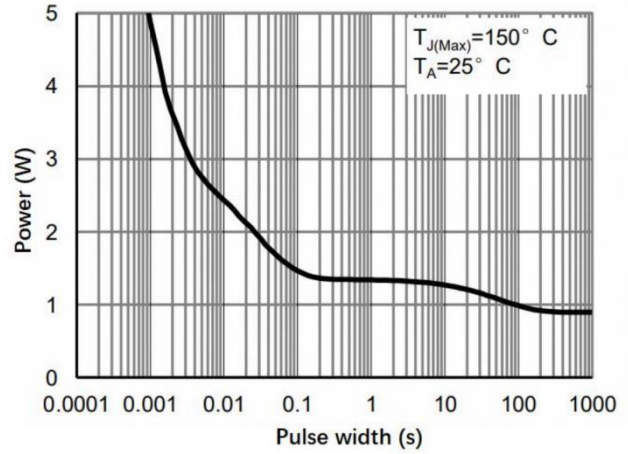


Figure8. Pulse Power Rating Junction-to Ambient

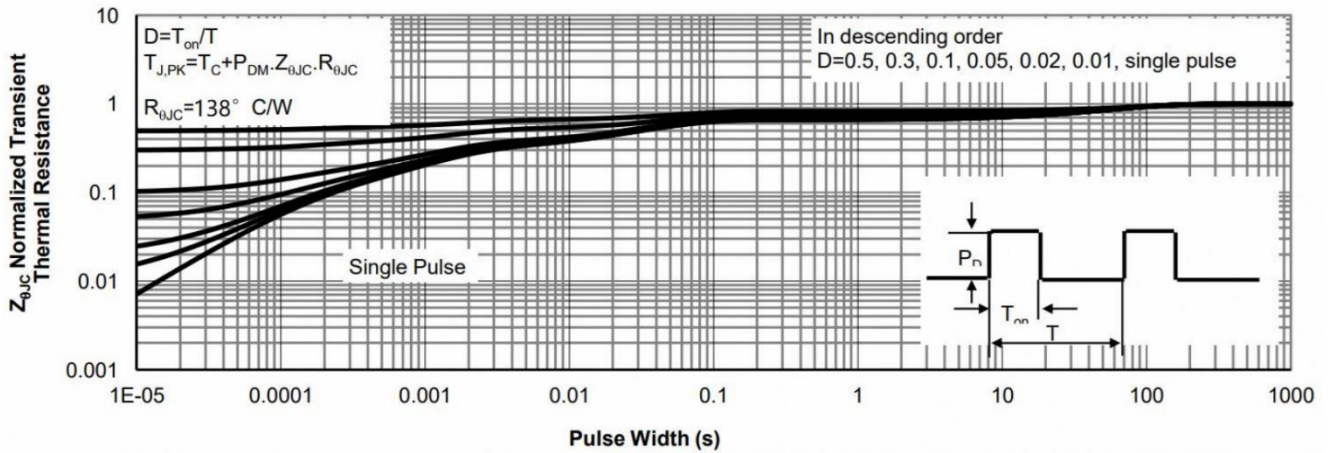
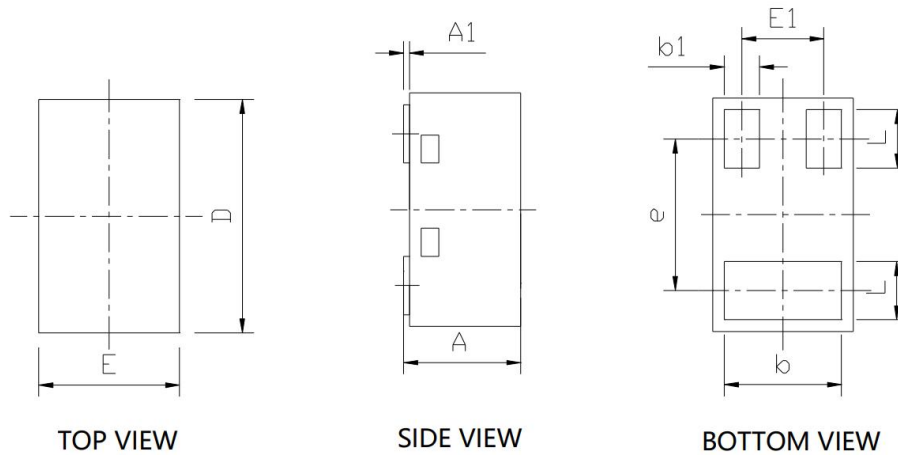


Figure9. Normalized Maximum Transient Thermal Impedance

### DFN1006-3L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.420	0.550	0.017	0.022
A1	0.025 REF		0.001 REF	
b	0.450	0.550	0.018	0.022
b1	0.100	0.200	0.004	0.008
D	0.950	1.050	0.037	0.041
E	0.550	0.650	0.022	0.026
E1	0.350 BSC		0.014 BSC	
e	0.650 BSC		0.026 BSC	
L	0.200	0.300	0.008	0.012